



PRM4R2N10CTB

PFC Device Corporation

100V Single N-Channel MOSFET

Major ratings and characteristics

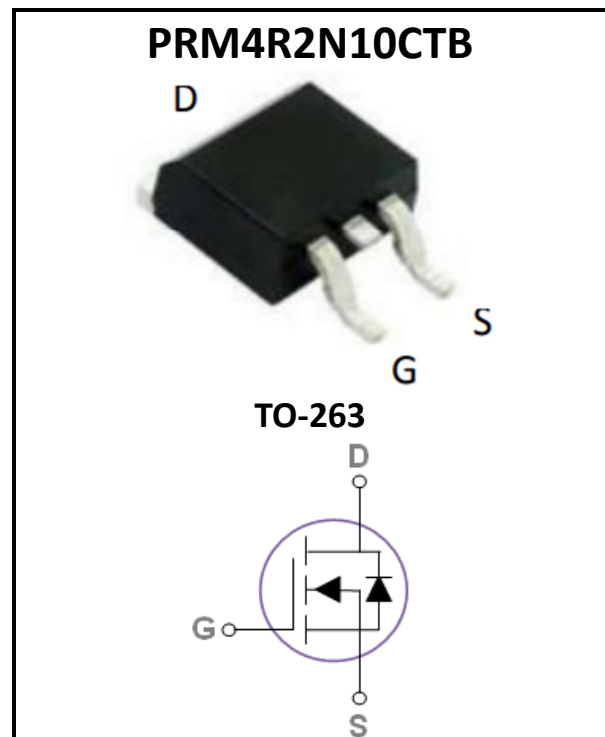
Characteristics	Values	Units
V_{DS}	100	V
I_D ($T_C=25^\circ\text{C}$)	185	A
Max. $R_{DS(ON)}$ @ $V_{GS}=10\text{V}$	4.2	m Ω
T_J Operating Junction Temperature	-55 to +150	$^\circ\text{C}$

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting



Features

- Max. $R_{DS(ON)}=4.2\text{m}\Omega$ @ $V_{GS}=10\text{V}$
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

1. Characteristics

Maximum Ratings Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	+20 / -12	V
I_D^4	Drain Current – Continuous ($T_C=25^\circ\text{C}$)	185	A
	Drain Current – Continuous ($T_C=100^\circ\text{C}$)	117	A
I_D^5	Drain Current – Continuous ($T_C=25^\circ\text{C}$)	110	A
I_{DM}	Drain Current – Pulsed ¹	440	A
E_{AS}	Single Pulse Avalanche Energy ²	125	mJ
I_{AS}	Single Pulse Avalanche Current ²	50	A
P_D	Power Dissipation ($T_C=25^\circ\text{C}$)	275	W
	Power Dissipation – Derate above 25°C	2.22	W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.45	$^\circ\text{C}/\text{W}$



Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=100V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=80V, V_{GS}=0V, T_J=85^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=20V, V_{DS}=0V$	---	---	100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=20A$	---	3.6	4.2	$m\Omega$
		$V_{GS}=4.5V, I_D=15A$	---	5.0	6.0	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.8	2.5	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=3A$	---	20	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge	$V_{DS}=80V, V_{GS}=10V, I_D=10A$	---	110	---	nC
Q_{gs}	Gate-Source Charge		---	13	---	
Q_{gd}	Gate-Drain Charge		---	32	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=50V, V_{GS}=10V, R_G=6\Omega, I_D=1A$	---	20	---	ns
T_r	Turn-On Rise Time		---	32	---	
$T_{d(off)}$	Turn-Off Delay Time		---	157	---	
T_f	Turn-Off Fall Time		---	115	---	
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1\text{MHz}$	---	6680	---	pF
C_{oss}	Output Capacitance		---	1690	---	
C_{rss}	Reverse Transfer Capacitance		---	200	---	
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1\text{MHz}$	---	1.2	---	Ω

Drain-Source Diode Characteristics

V_{SD}^3	Source to Drain Diode Voltage	$V_{GS}=0V, I_S=1A$	---	---	1	V
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Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $L=0.1\text{mH}, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Silicon limited.
5. Package limited.



2. Characteristics Curves

Ratings and Characteristics Curves

($T_A = 25^\circ\text{C}$ unless otherwise specified)

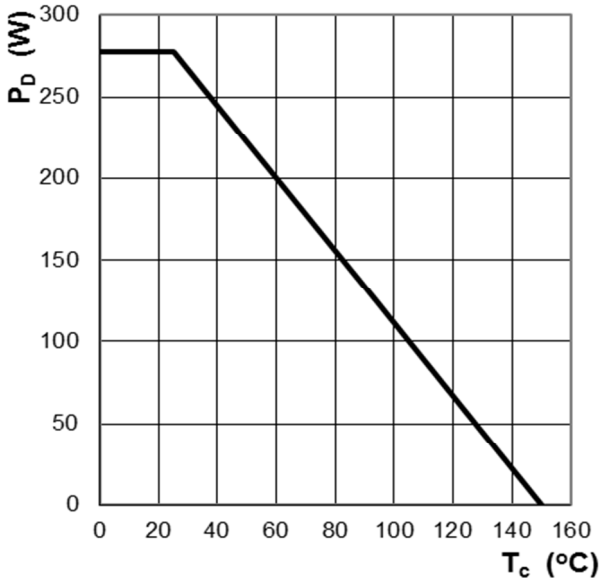


Figure 1: Power Dissipation

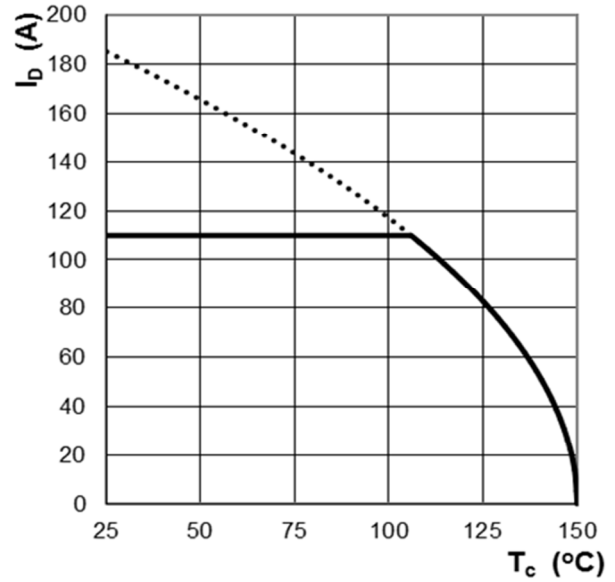


Figure 2: Continuous Drain Current vs. T_c

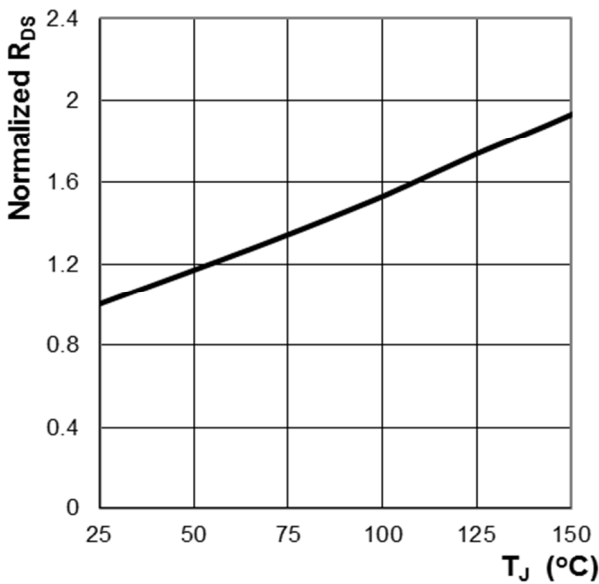


Figure 3: Normalized $R_{DS(on)}$ vs. T_J

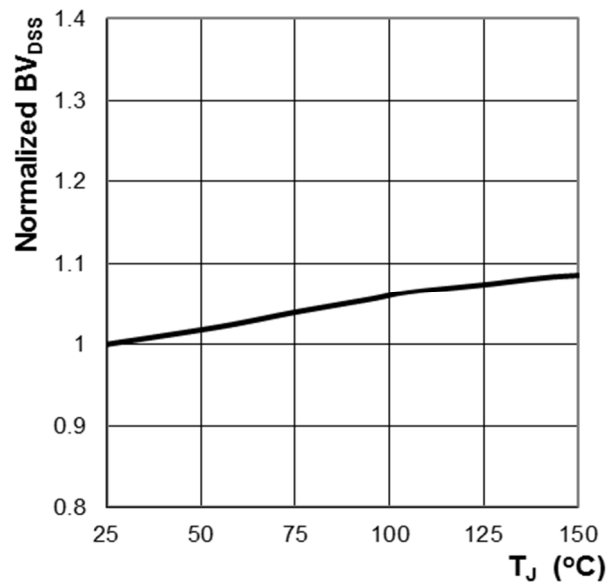


Figure 4: Normalized BV_{DSS} vs. T_J



Ratings and Characteristics Curves

($T_A = 25^\circ\text{C}$ unless otherwise specified)

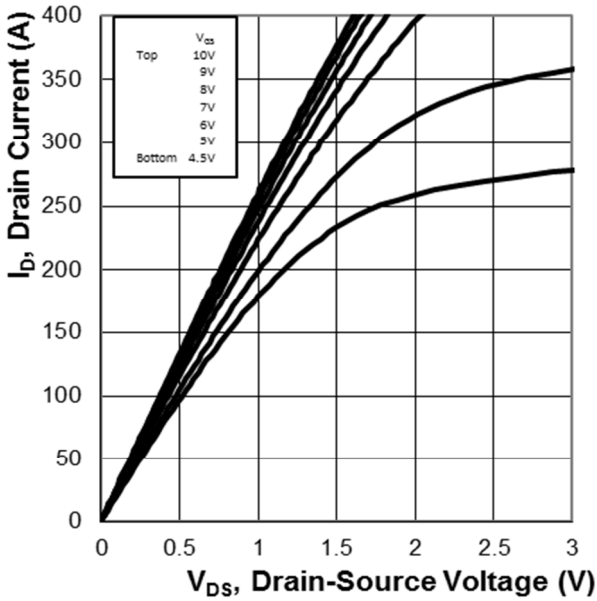


Figure 5: On-Region Characteristics

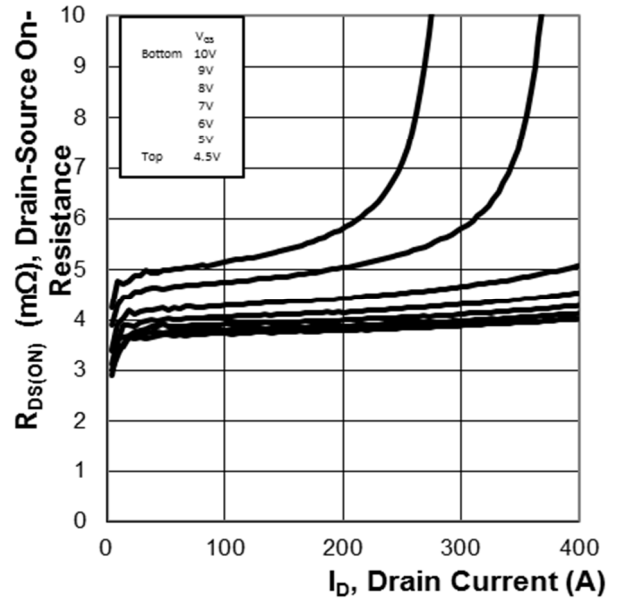


Figure 6: Typ. R_{DS} Variation vs. I_D and V_{GS}

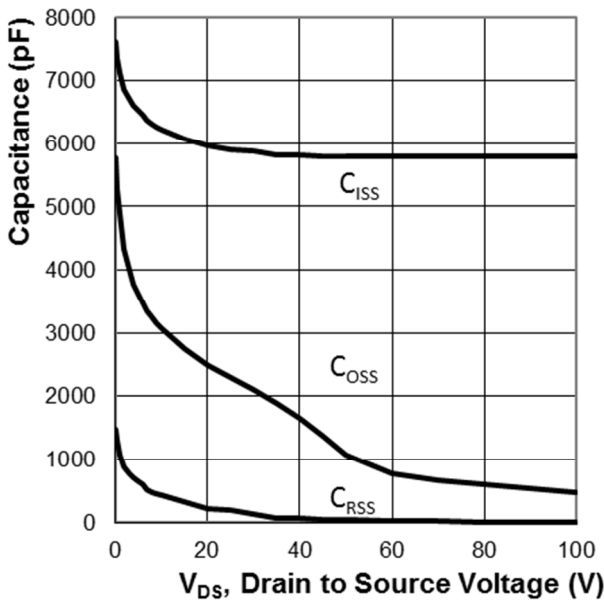


Figure 7: Typ. Capacitance Characteristics

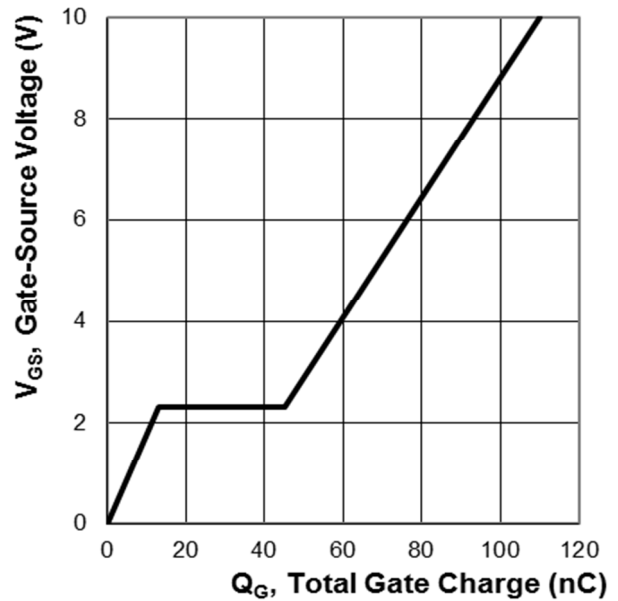


Figure 8: Typ. Gate Charge Characteristics



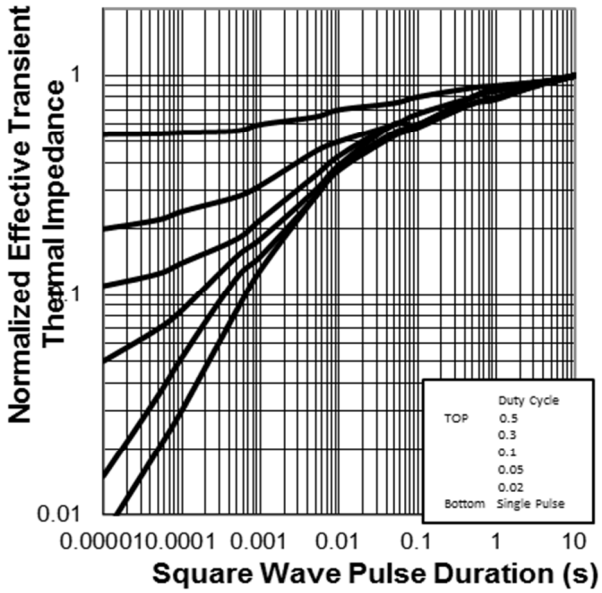


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

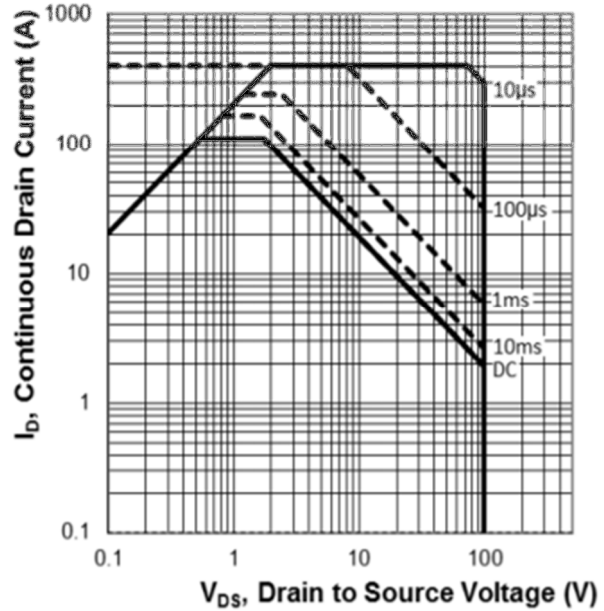
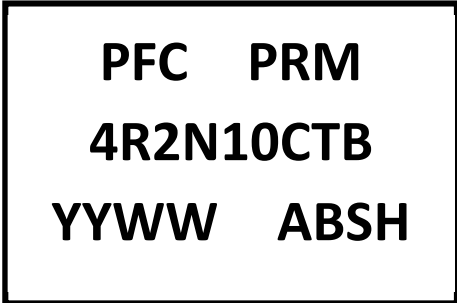


Figure 10: Maximum Safe Operation Area



3. Marking information

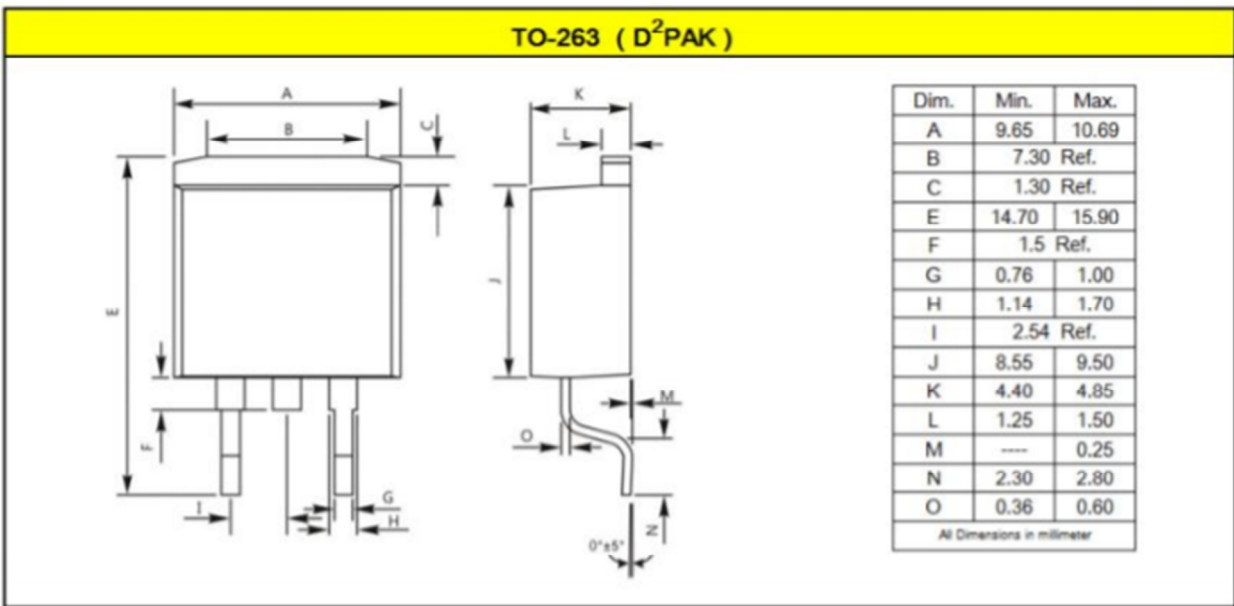
Top Marking Rule



PRM4R2N10CTB = Product Type Marking Code
 YYWW = Date Code
 YY = Last two digits of year
 WW = Week code
 ABS = Assembly code
 H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters



5. Ordering information

Part Number	Package	Delivery mode
PRM4R2N10CTB	TO-263	800 pcs / 13" diameter reel

Mechanical

- Molder Plastic: UL Flammability Classification Rating 94V-0
- Device Weight : 0.04 ounces (1.16grams) - TO-263
- Mounting Torque : Recommended 4~5 kg-cm

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